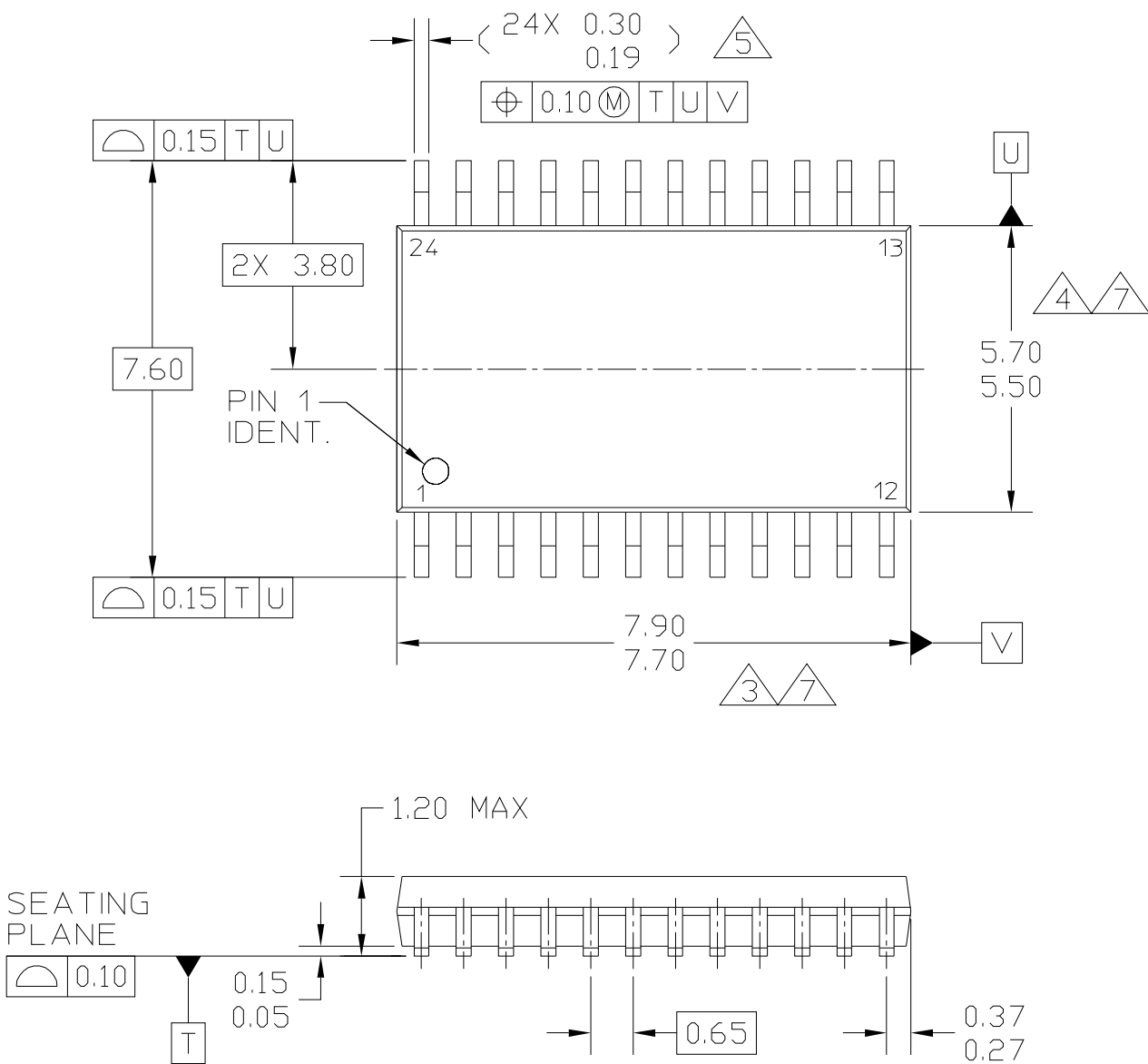
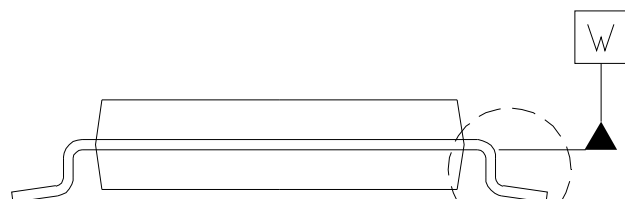
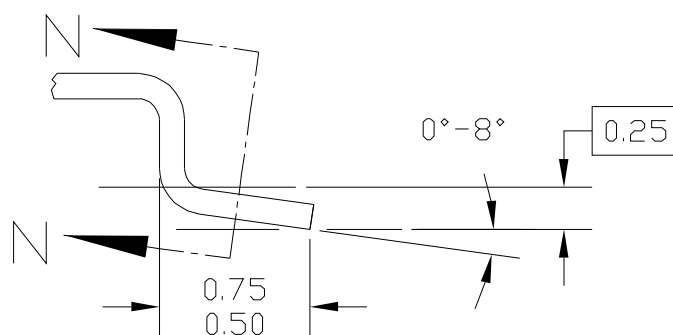




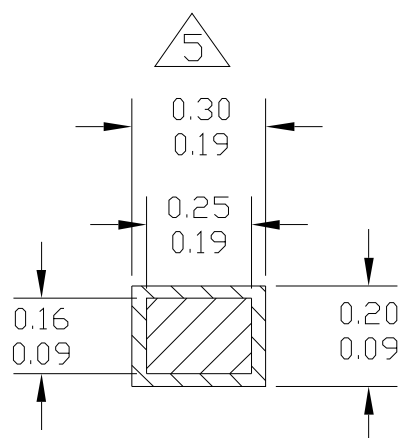
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TITLE: 24 LD TSSOP, WIDE BODY		DOCUMENT NO: 98ASH70455A	REV: C
		STANDARD: NON-JEDEC	
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DETAIL E



DETAIL E



SECTION N-N

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		STANDARD: NON-JEDEC	
		SOT1771-1	02 MAR 2016



NOTES:

1. CONTROLLING DIMENSION: MILLIMETER

2. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

△3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

△4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD
FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE.

△5. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF THE DIMENSION AT MAXIMUM
MATERIAL CONDITION.

6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

△7. DIMENSIONS ARE TO BE DETERMINED AT DATUM PLANE -W-.

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